



2.0A SCHOTTKY BARRIER RECTIFIER

Product Summary

V _{RRM} (V)	I ₀ (A)	V _F (MAX) (V) @ +25°C	I _{R(MAX)} (mA) @ +25°С
40	2	0.5	0.2

Description and Applications

The Schottky rectifier providing low VF and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

- Boost Diode .
- **Blocking Diode**
- **Recirculating Diode**

Features and Benefits

- Reduced Low Forward Voltage Drop (V_F); Better Efficiency and **Cooler Operation**
- Reduced High-temperature Reverse Leakage; Increased Reliability against Thermal Runaway Failure in High Temperature Operation.
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOD123F (Generic) •
- Case Material: Molded Plastic, "Green" Molding Compound. UL . Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Polarity: Cathode Band
- Weight: 0.015 grams (Approximate)



Top View

Ordering Information (Note 4)

B240S1F-7 SOD123F (Generic) 3,000/Tape & Reel	Part Number Case Packaging						
B240S1F-7 SOD123F (Generic) 3,000/Tape & Reel	Fait Nullibei	Case	Fackaying				
		SOD123F (Generic)	3,000/Tape & Reel				

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

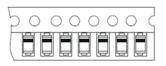
and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



B24= Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017)M = Month (ex: 2 = February)



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Date Code Kev

Code

Notes:

Year		2015	2016	20	017	2018	201	9	2020	2021		2022
Code		С	D		E	F	G		Н	1		J
Month	Jan	Feb	Mar	Δnr	Mav	Jun	Jul	Διια	Sen	Oct	Nov	Dec

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	40	V
Average Rectified Output Current	Ιo	2	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	50	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{0JA}	100	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	R _{θJC}	50	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

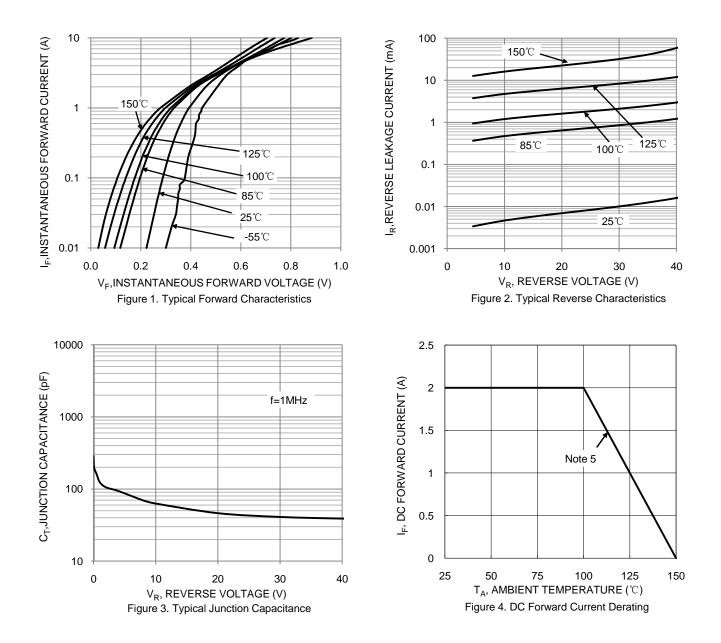
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Valtage Drop	V	_	0.45	0.50	V	$I_{F} = 2A, T_{J} = +25^{\circ}C$
Forward Voltage Drop	VF	—	0.40	—	v	$I_F = 2A, T_J = +125^{\circ}C$
Leokere Current (Note 6)		_	0.02	0.2		V _R = 40V, T _J = +25°C
Leakage Current (Note 6)	IR	—	12.6	—	mA	$V_R = 40V, T_J = +25^{\circ}C$ $V_R = 40V, T_J = +125^{\circ}C$
Typical Capacitance	CT		100		pF	$V_R = 4.0V$, f = 1MHz

Notes:

Device mounted on FR-4 substrate, 0.4" x 0.5", 2oz, single-sided, PC boards with 0.2" x 0.25" copper pad.
Short duration pulse test used to minimize self-heating effect.



B240S1F

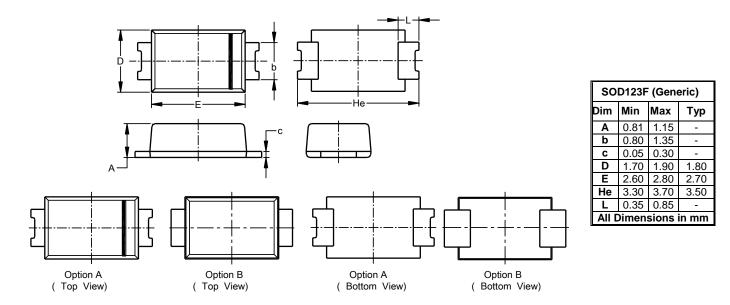




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

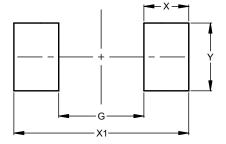
SOD123F (Generic)



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123F (Generic)



Dimensions	Value
Dimensions	(in mm)
G	1.90
Х	1.00
X1	3.90
Y	1.50



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